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SUBMIT AN ABSTRACT FOR THE FOLLOWING TMS2024 SYMPOSIUM:

ELECTRONIC, MAGNETIC, AND ENERGY MATERIALS

Phase Stability, Phase Transformations, and Reactive Phase Formation in Electronic Materials XXIII

This is the 23rd in a series of TMS symposia addressing the stability, transformation, and formation of phases during the fabrication, processing, and utilization of electronic materials and devices.

Topics of interests range from microelectronic technologies to advanced energy technologies, including phase stability, transformation, formation, and morphological evolution of electronic packaging materials, interconnection materials, integrated circuit materials, optoelectronic materials as well as energy storage and generating materials.

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